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Electronic Patent Application Submission
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EFS ID: 60087
Application ID: 10643638 
Title of Invention: BOILING TEMPERATURE DESIGN
IN PUMPED MICROCHANNEL
COOLING LOOPS
First Named Inventor: Peng Zhou
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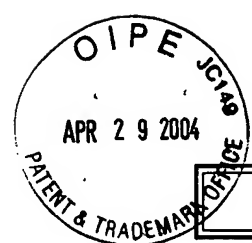
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TRANSMITTAL

Electronic Version v1.1
Stylesheet Version v1.1.0

Title of Invention	BOILING TEMPERATURE DESIGN IN PUMPED MICROCHANNEL COOLING LOOPS									
Application Number: 10/643638 										
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<table border="1"><thead><tr><th>Submitted by:</th><th>Elec. Sign.</th><th>Sign. Capacity</th></tr></thead><tbody><tr><td>Thomas B. Haverstock Registered Number: 32571</td><td>/tbh/</td><td>Attorney</td></tr></tbody></table>			Submitted by:	Elec. Sign.	Sign. Capacity	Thomas B. Haverstock Registered Number: 32571	/tbh/	Attorney		
Submitted by:	Elec. Sign.	Sign. Capacity								
Thomas B. Haverstock Registered Number: 32571	/tbh/	Attorney								
<table><tr><td>Documents being submitted</td><td>Files</td></tr><tr><td>us-ids</td><td>COOL01500C-usidst.xml</td></tr><tr><td></td><td>us-ids.dtd</td></tr><tr><td></td><td>us-ids.xsl</td></tr></table>			Documents being submitted	Files	us-ids	COOL01500C-usidst.xml		us-ids.dtd		us-ids.xsl
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us-ids	COOL01500C-usidst.xml									
	us-ids.dtd									
	us-ids.xsl									
Comments										



ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

Title of
Invention

BOILING TEMPERATURE DESIGN IN PUMPED
MICROCHANNEL COOLING LOOPS

Application Number: 10/643638



Confirmation Number: 4432

First Named Applicant: Peng Zhou

Attorney Docket Number:

Search string: (6068752 or 6090251 or 6096656 or 6100541
or 6101715 or 6119729 or 6126723 or 6129145
or 6129260 or 6131650 or 6146103 or 6154363
or 6159353 or 6171067 or 6174675 or 6176962
or 6186660 or 6210986 or 6216343 or 6221226
or 6227809 or 6234240 or 6238538 or 6277257
or 6287440 or 6301109 or 6313992 or 6317326
or 6321791 or 6322753 or 6324058 or 6351384
or 6337794 or 6388317 or 6396706 or 6400012
or 6406605 or 6415860 or 6416642 or 6417060
or 6424531 or 6443222 or 6444461 or 6457515
or 6495015 or 6537437 or 6543521 or 6553253
or 6572749 or 6588498).pn.

US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
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Signature

Examiner Name	Date